



(2) D

(3) s Schematic diagram

NCE

NCEP12T12D

XXXXX

Marking and pin assignment

TO-263-2L top view

(1) G C

# NCE N-Channel Super Trench Power MOSFET

#### Description

The NCEP12T12D uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

## **General Features**

- V<sub>DS</sub> =120V,I<sub>D</sub> =129A
  R<sub>DS(ON)</sub> <5.3mΩ @ V<sub>GS</sub>=10V
- Excellent gate charge x R<sub>DS(on)</sub> product
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

## Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED!

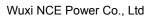
100% ΔVds TESTED!

## **Package Marking and Ordering Information**

| Device Marking | Device     | Device Package | Reel Size | Tape width | Quantity |
|----------------|------------|----------------|-----------|------------|----------|
| NCEP12T12D     | NCEP12T12D | TO-263-2L      | -         | -          | -        |

## Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

| Parameter  | Symbol                           | Limit      | Unit |  |
|--|----------------------------------|------------|------|--|
| Drain-Source Voltage                             | VDS                              | 120        | V    |  |
| Gate-Source Voltage                              | Vgs                              | ±20        | V    |  |
| Drain Current-Continuous                         | Ι <sub>D</sub>                   | 129        | А    |  |
| Drain Current-Continuous(Tc=100℃)                | I <sub>D</sub> (100℃)            | 92         | А    |  |
| Pulsed Drain Current                             | I <sub>DM</sub>                  | 480        | А    |  |
| Maximum Power Dissipation                        | PD                               | 185        | W    |  |
| Derating factor                                  |                                  | 1.3        | W/℃  |  |
| Single pulse avalanche energy (Note 5)           | E <sub>AS</sub>                  | 1000       | mJ   |  |
| Operating Junction and Storage Temperature Range | T <sub>J</sub> ,T <sub>STG</sub> | -55 To 175 | °C   |  |









## **Thermal Characteristic**

## Electrical Characteristics (T<sub>c</sub>=25 $^{\circ}$ C unless otherwise noted)

| Parameter                          | Symbol              | Condition   | Min | Тур  | Max  | Unit |
|------------------------------------|---------------------|---|-----|------|------|------|
| Off Characteristics                | · · ·               |   | •   | •    |      |      |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250µA               | 120 |      | -    | V    |
| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>    | V <sub>DS</sub> =120V,V <sub>GS</sub> =0V               | -   | -    | 1    | μA   |
| Gate-Body Leakage Current          | I <sub>GSS</sub>    | $V_{GS}$ =±20V, $V_{DS}$ =0V                            | -   | -    | ±100 | nA   |
| On Characteristics (Note 3)        |                     |   |     |      |      |      |
| Gate Threshold Voltage             | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA | 2.5 | 3.3  | 4.5  | V    |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =60A               | -   | 4.8  | 5.3  | mΩ   |
| Forward Transconductance           | <b>g</b> fs         | V <sub>DS</sub> =10V,I <sub>D</sub> =60A                | 60  | -    | -    | S    |
| Dynamic Characteristics (Note4)    | I                   |   |     |      |      |      |
| Input Capacitance                  | C <sub>lss</sub>    |   | -   | 5600 | -    | PF   |
| Output Capacitance                 | C <sub>oss</sub>    | V <sub>DS</sub> =50V,V <sub>GS</sub> =0V,<br>F=1.0MHz   | -   | 641  | -    | PF   |
| Reverse Transfer Capacitance       | C <sub>rss</sub>    | F=1.0MHZ  | -   | 28   | -    | PF   |
| Switching Characteristics (Note 4) |                     |   |     |      |      |      |
| Turn-on Delay Time                 | t <sub>d(on)</sub>  |   | -   | 16   | -    | nS   |
| Turn-on Rise Time                  | tr                  | V <sub>DD</sub> =60V,I <sub>D</sub> =60A                | -   | 67   | -    | nS   |
| Turn-Off Delay Time                | t <sub>d(off)</sub> | $V_{GS}$ =10V,R <sub>G</sub> =4.7 $\Omega$              | _   | 45   | -    | nS   |
| Turn-Off Fall Time                 | t <sub>f</sub>      |   | _   | 14   | -    | nS   |
| Total Gate Charge                  | Qg                  | V/ 00V/1 00A  | -   | 84.7 |      | nC   |
| Gate-Source Charge                 | Q <sub>gs</sub>     | $V_{DS}$ =60V,I <sub>D</sub> =60A,                      | _   | 30.6 |      | nC   |
| Gate-Drain Charge                  | Q <sub>gd</sub>     | V <sub>GS</sub> =10V                                    | -   | 18.3 |      | nC   |
| Drain-Source Diode Characteristics |                     |   |     |      |      |      |
| Diode Forward Voltage (Note 3)     | V <sub>SD</sub>     | V <sub>GS</sub> =0V,I <sub>S</sub> =129A                | -   |      | 1.2  | V    |
| Diode Forward Current (Note 2)     | I <sub>S</sub>      |   | -   | -    | 129  | А    |
| Reverse Recovery Time              | trr                 | $T_J$ = 25°C, $I_F$ = $I_S$                             | -   | 60   |      | nS   |
| Reverse Recovery Charge            | Qrr                 | di/dt = 100A/µs <sup>(Note3)</sup>                      | -   | 140  |      | nC   |

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t  $\leq$  10 sec.

3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.

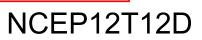
4. Guaranteed by design, not subject to production

5. EAS condition : Tj=25  $^\circ \!\! \mathbb{C}$  ,V\_{DD}=50V,V\_G=10V,L=0.5mH,Rg=25\Omega

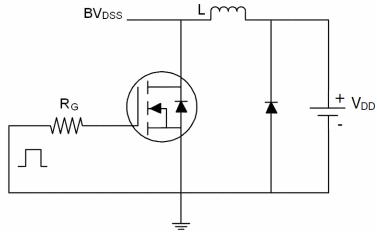


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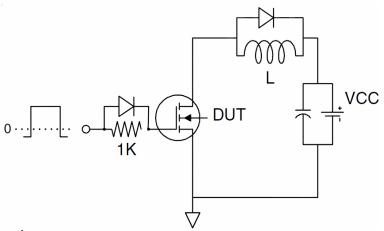
**Pb Free Product** 



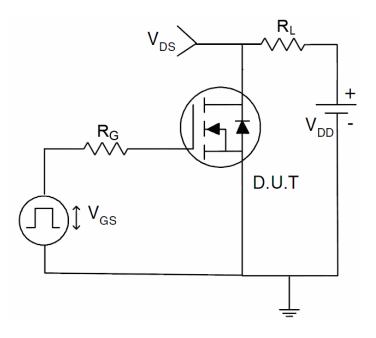
## Test Circuit 1) E<sub>AS</sub> test Circuit



## 2) Gate charge test Circuit



## 3) Switch Time Test Circuit

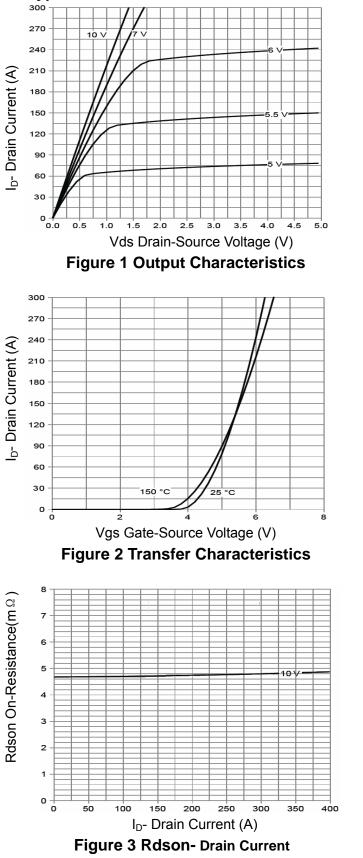












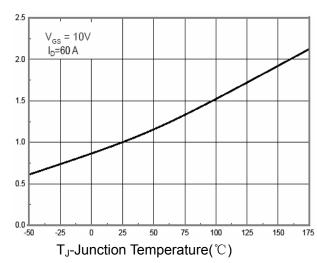


Figure 4 Rdson-JunctionTemperature

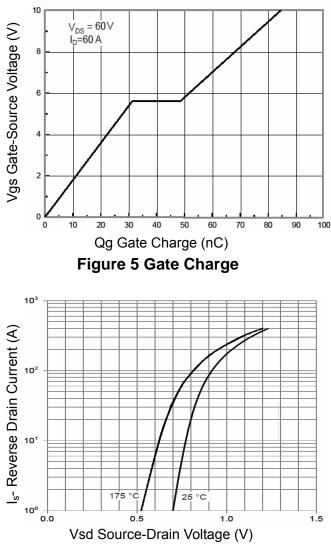


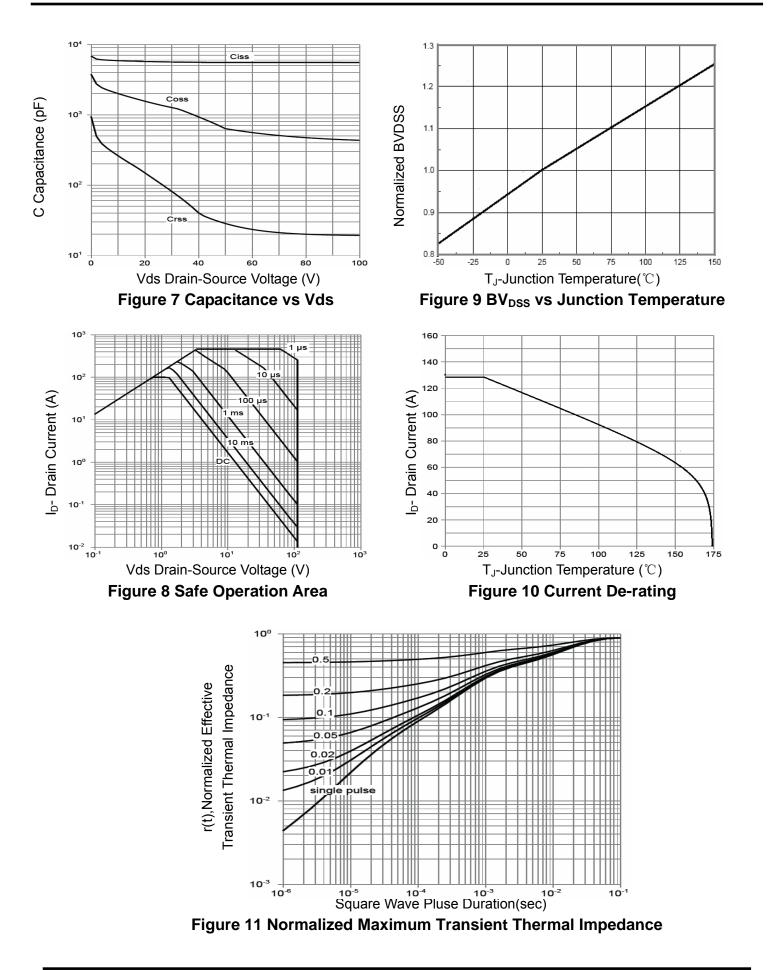
Figure 6 Source- Drain Diode Forward



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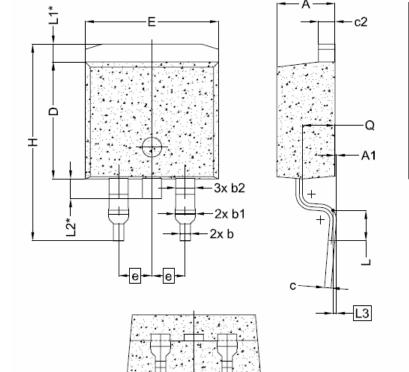


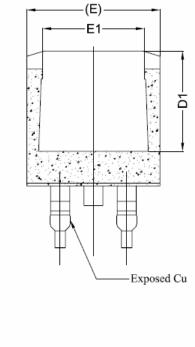
NCEP12T12D



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## TO-263-2L Package Information





| Symbol | Dimensions In Millimeters |           |       |  |  |
|--------|---------------------------|-----------|-------|--|--|
| Symbol | Min.                      | Nom.      | Max.  |  |  |
| A      | 4.24                      | 4.24 4.44 |       |  |  |
| A1     | 0.00                      | 0.10      | 0.25  |  |  |
| b      | 0.70                      | 0.80      | 0.90  |  |  |
| b1     | 1.20                      | 1.55      | 1.75  |  |  |
| b2     | 1.20                      | 1.45      | 1.70  |  |  |
| с      | 0.40                      | 0.50      | 0.60  |  |  |
| c2     | 1.15                      | 1.27      | 1.40  |  |  |
| D      | 8.82                      | 8.92      | 9.02  |  |  |
| D1     | 6.86                      | 7.65      | -     |  |  |
| E      | 9.96                      | 10.16     | 10.36 |  |  |
| E1     | 6.89                      | 7.77      | 7.89  |  |  |
| е      | 2.54BSC                   |           |       |  |  |
| Н      | 14.61                     | 15.00     | 15.88 |  |  |
| L      | 1.78                      | 1.78 2.32 |       |  |  |
| L1     | 1.36 REF.                 |           |       |  |  |
| L2     | 1.50 REF.                 |           |       |  |  |
| L3     | 0.25 BSC                  |           |       |  |  |
| Q      | 2.30                      | 2.48      | 2.70  |  |  |







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